CRMQTL0406A

N-Channel 40V, 6.1mΩ Typ. Power MOSFET

Description

Features

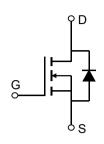
• 40V, 45A

$$R_{DS(ON)}$$
 Typ = 6.1m Ω @ V_{GS} = 10V
 $R_{DS(ON)}$ Typ = 8.4m Ω @ V_{GS} = 4.5V

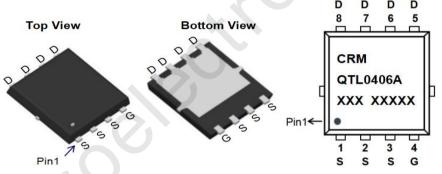
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management







Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMQTL0406A	CRMQTL0406A	PDFN3.3x3.3-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		40	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Paris Comment	T _C = 25°C	45	Α
I _D	Continuous Drain Current	T _C = 100°C	27	Α
I _{DM}	Pulsed Drain Current (1)		180	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		64	mJ
P _D	Power Dissipation	T _C = 25°C	27.2	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		4.6	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Initial Version: 1.0

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Char	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	40	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 40V, V_{GS} = 0V$	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5	2	V
В		$V_{GS} = 10V, I_D = 20A$	-	6.1	7.9	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 4.5V, I _D = 10A	-	8.4	10.9	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	2177	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 20V,$ f = 1MHz	-	150	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11VII 12		133	-	pF
Q_g	Total Gate Charge		<u></u>	45	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 20V, I_{D} = 20A$	-	8	-	nC
Q_gd	Gate Drain("Miller") Charge	V _{DS} - 20V, I _D - 20A	-	11	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	12	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 20V$	-	25	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 20A$, $R_{GEN} = 3\Omega$	-	43	-	ns
$t_{\rm f}$	Turn-Off Fall Time		-	10	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	45	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	180	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 15A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	L = 201 di/dt = 1001/:	-	11	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$, di/dt = 100A/us	-	5	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =20V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =16A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

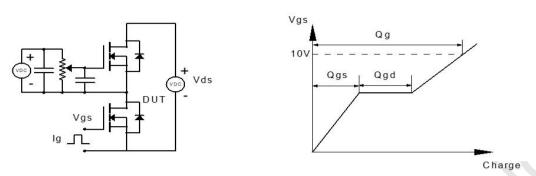


Figure 1: Gate Charge Test Circuit & Waveform

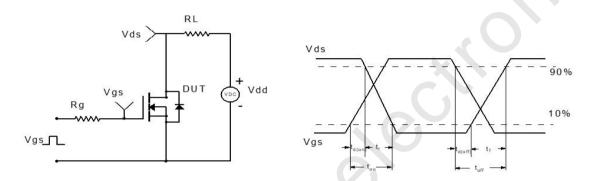


Figure 2: Resistive Switching Test Circuit & Waveform

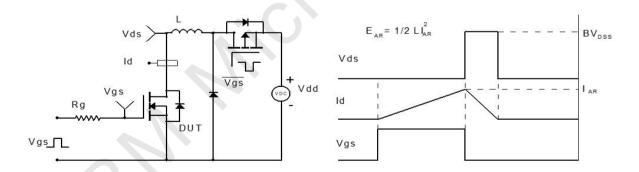


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

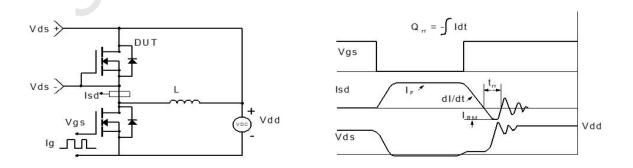
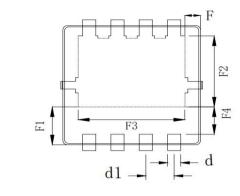


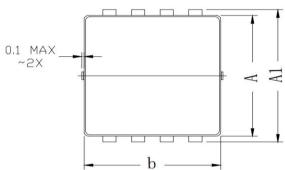
Figure 4: Diode Recovery Test Circuit & Waveform

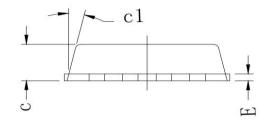
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Package Mechanical Data(PDFN3.3x3.3-8L)







	COMMON DIN	MENSION (MM)	
PKG		PDFN 3.3×3.3-8	BL
SYMBOL	MIN	TYP	MAX
Α	3.070	3.100	3.130
A1	3. 300	3, 400	3.500
b	3.070	3. 100	3.130
С	0.770	0.800	0. 830
c1	-	13°	8-
d	0. 275	0. 300	0. 325
d1	0. 625	0.650	0. 675
E	0. 144	0. 152	0. 160
F	0. 300	0. 325	0. 350
F1	0. 960	0. 985	1.010
F2	1. 775	1.800	1.825
F3	2. 425	2. 450	2. 475
F4	0. 660	0. 685	0.710

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Contact information

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